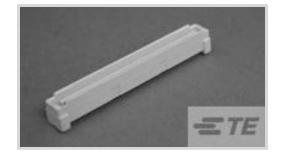
5179030-8 - ACTIVE

Free Height

TE Internal #: 5179030-8 PCB Mount Header, Vertical, Board-to-Board, 160 Position, .031 in [. 8 mm] Centerline, Fully Shrouded, Gold, Surface Mount, Signal, Free Height

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > Free Height Plug Connector: Board-Board, Vertical, 160, 0.8mm



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 160

Centerline (Pitch): .8 mm [.031 in]

All Free Height Plug Connector: Board-Board, Vertical, 160, 0.8mm (20)

Features

Product Type Features

PCB Connector Assembly Type

Connector System

PCB Mount Header

Board-to-Board



Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	160
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	500 VAC
Insulation Resistance	2 MΩ
Operating Voltage	100 VAC
Body Features	
Primary Product Color	Natural

PCB Mount Header, Vertical, Board-to-Board, 160 Position, .031 in [.8 mm] Centerline, Fully Shrouded, Gold, Surface Mount, Signal, Free Height



Contact Features

Contact Layout	Inline
PCB Contact Termination Area Plating Material Thickness	2 μm[78.74 μin]
Mating Tab Width	.4 mm[.016 in]
Mating Tab Thickness	.2 mm[.008 in]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Base Material Contact Mating Area Plating Material	Brass Gold
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness	Gold .2 µm[8 µin]
Contact Mating Area Plating Material Contact Mating Area Plating Material Thickness Contact Type	Gold .2 µm[8 µin] Tab

Rectangular Termination Post & Tail Width	.25 mm[.01 in]
Termination Method to Printed Circuit Board	Surface Mount

Mechanical Attachment

PCB Mount Alignment Type	Positioning Bosses
Locating Post Length	.5 mm[.02 in]
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Mating Entry Location	Тор
Centerline (Pitch)	.8 mm[.031 in]
Housing Material	Matte
Dimensions	
Connector Height	7 mm[.276 in]
Stack Height	7 mm, 11 mm, 15 mm, 19 mm[.276 in][.433 in][.591 in][.748 in]

PCB Mount Header, Vertical, Board-to-Board, 160 Position, .031 in [.8 mm] Centerline, Fully Shrouded, Gold, Surface Mount, Signal, Free Height



Usage Conditions

Housing Temperature Rating	High
Operating Temperature Range	-40 – 125 °C[-40 – 257 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
	.5 in
Packaging Quantity	6
Packaging Type	Box, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

PCB Mount Header, Vertical, Board-to-Board, 160 Position, .031 in [.8 mm] Centerline, Fully Shrouded, Gold, Surface Mount, Signal, Free Height



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Free Height



PCB Headers & Receptacles(760)

Customers Also Bought





Documents

Product Drawings

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 160 Position, .031 in [.8 mm] Centerline, Fully Shrouded, Gold, Surface Mount, Signal, Free Height



0.8FH,P07H.5,160,08/Sn,TU

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5179030-8_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5179030-8_B.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_5179030-8_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Fine Pitch Stacking Connectors - 0.8mm Free Height (FH) Connectors

English

Product Specifications

Product Specification

English

Product Specification

English